



STx13NM60N

N-channel 600 V, 0.28 Ω , 11 A MDmesh™ II Power MOSFET
in D²PAK, DPAK, TO-220FP, I²PAK, TO-220, IPAK, TO-247

Features

| Order codes | V _{DSS} (@T _{jmax}) | R _{DS(on)} max | I _D |
|--|---|----------------------------|----------------|
| STB13NM60N STD13NM60N STF13NM60N STI13NM60N STP13NM60N STU13NM60N STW13NM60N | 650 V | < 0.36 Ω | 11 A |

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

Applications

- Switching applications

Description

These devices are N-channel Power MOSFETs developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

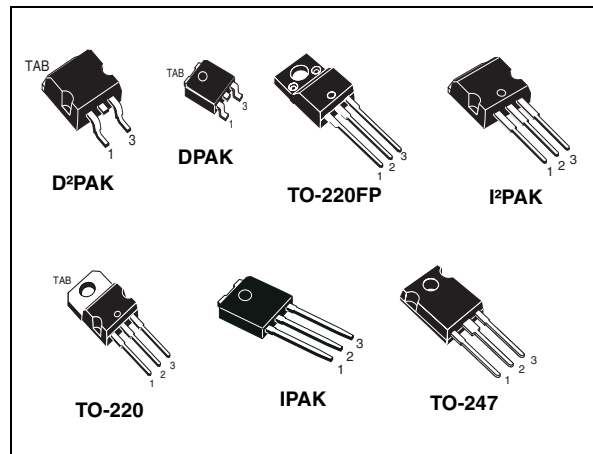


Figure 1. Internal schematic diagram

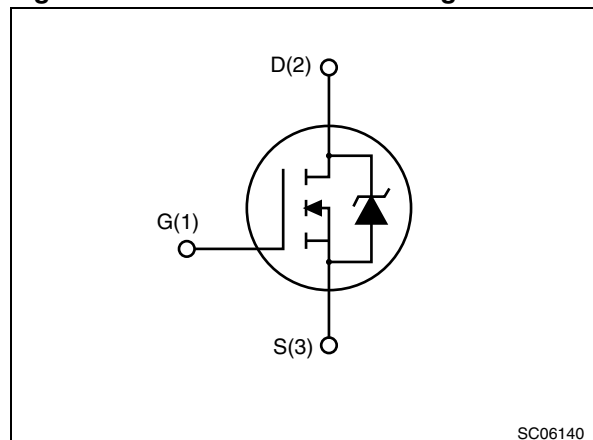


Table 1. Device summary

| Order codes | Marking | Packages | Packaging |
|--|---------|--|--|
| STB13NM60N STD13NM60N STF13NM60N STI13NM60N STP13NM60N STU13NM60N STW13NM60N | 13NM60N | D ² PAK DPAK TO-220FP I ² PAK TO-220 IPAK TO-247 | Tape and reel Tape and reel Tube Tube Tube Tube Tube |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | | | Unit |
|--------------------------------|---|----------------------------|---------------------|--|------|
| | | D ² PAK DPAK | TO-220FP | I ² PAK, TO-220, IPAK, TO-247 | |
| V _{DS} | Drain-source voltage (V _{GS} = 0) | 600 | | | V |
| V _{GS} | Gate-source voltage | ± 25 | | | V |
| I _D | Drain current (continuous) at T _C = 25 °C | 11 | 11 ⁽¹⁾ | 11 | A |
| I _D | Drain current (continuous) at T _C = 100 °C | 6.93 | 6.93 ⁽¹⁾ | 6.93 | A |
| I _{DM} ⁽²⁾ | Drain current (pulsed) | 44 | 44 ⁽¹⁾ | 44 | A |
| P _{TOT} | Total dissipation at T _C = 25 °C | 90 | 25 | 90 | W |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 15 | | | V/ns |
| V _{ISO} | Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T _C =25 °C) | | 2500 | | V |
| T _{stg} | Storage temperature | - 55 to 150 | | | °C |
| T _j | Max. operating junction temperature | 150 | | | °C |

- Limited by maximum junction temperature
- Pulse width limited by safe operating area
- I_{SD} ≤ 11 A, di/dt ≤ 400 A/μs, V_{DS peak} ≤ V_{(BR)DSS}, V_{DD} = 80% V_{(BR)DSS}.

Table 3. Thermal data

| Symbol | Parameter | Value | | | | | | Unit |
|-----------------------|--|--------------------|------|----------|--------------------|--------|------|------|
| | | D ² PAK | DPAK | TO-220FP | I ² PAK | TO-220 | IPAK | |
| R _{thj-case} | Thermal resistance junction-case max | 1.39 | | 5 | 1.39 | | | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | | | 62.5 | 62.5 | 100 | 50 | °C/W |
| R _{thj-pcb} | Thermal resistance junction-pcb max | 30 | 50 | | | | | °C/W |

Table 4. Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|----------|---|-------|------|
| I_{AS} | Avalanche current, repetitive or not-repetitive (pulse width limited by T_J max) | 3.5 | A |
| E_{AS} | Single pulse avalanche energy (starting $T_J=25\text{ °C}$, $I_D=I_{AS}$, $V_{DD}=50\text{ V}$) | 200 | mJ |

2 Electrical characteristics

($T_{CASE} = 25\text{ °C}$ unless otherwise specified)

Table 5. On/off states

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|--|---|------|------|----------|--------------------------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage ($V_{GS} = 0$) | $I_D = 1\text{ mA}$ | 600 | | | V |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 600\text{ V}$ $V_{DS} = 600\text{ V}, T_C = 125\text{ °C}$ | | | 1 100 | μA μA |
| I_{GSS} | Gate-body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 25\text{ V}$ | | | 0.1 | μA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$ | 2 | 3 | 4 | V |
| $R_{DS(on)}$ | Static drain-source on resistance | $V_{GS} = 10\text{ V}, I_D = 5.5\text{ A}$ | | 0.28 | 0.36 | Ω |

Table 6. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|----------------------------|-------------------------------|--|------|------|------|---------------|
| C_{iss} | Input capacitance | $V_{DS} = 50\text{ V}, f = 1\text{ MHz},$ $V_{GS} = 0$ | - | 790 | - | μF |
| C_{oss} | Output capacitance | | | 60 | | |
| C_{rss} | Reverse transfer capacitance | | | 3.6 | | |
| $C_{oss\text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{GS} = 0, V_{DS} = 0\text{ to }480\text{ V}$ | - | 135 | - | μF |
| Q_g | Total gate charge | $V_{DD} = 480\text{ V}, I_D = 11\text{ A},$ $V_{GS} = 10\text{ V},$ <i>(see Figure 19)</i> | - | 30 | - | nC |
| Q_{gs} | Gate-source charge | | | 4 | | |
| Q_{gd} | Gate-drain charge | | | 15 | | |
| R_G | Gate input resistance | $f = 1\text{ MHz open drain}$ | - | 4.7 | - | Ω |

1. $C_{oss\text{ eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit | |
|--------------|---------------------|---|------|------|------|------|----|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 300\text{ V}$, $I_D = 5.5\text{ A}$ $R_G = 4.7\ \Omega$, $V_{GS} = 10\text{ V}$ (see Figure 18) | | 3 | | ns | |
| t_r | Rise time | | | 8 | | ns | |
| $t_{d(off)}$ | Turn-off delay time | | | | 30 | | ns |
| t_f | Fall time | | | | 10 | | ns |

Table 8. Source drain diode

| Symbol | Parameter | Test conditions | Min | Typ. | Max | Unit | |
|-----------------|-------------------------------|---|-----|------|-----|------|---------------|
| I_{SD} | Source-drain current | | | | 11 | A | |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | | 44 | A | |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 11\text{ A}$, $V_{GS} = 0$ | - | | 1.5 | V | |
| t_{rr} | Reverse recovery time | $I_{SD} = 11\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 100\text{ V}$ (see Figure 20) | | 230 | | ns | |
| Q_{rr} | Reverse recovery charge | | | - | 2 | | μC |
| I_{RRM} | Reverse recovery current | | | | 18 | | A |
| t_{rr} | Reverse recovery time | $I_{SD} = 11\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$ $V_{DD} = 100\text{ V}$, $T_j = 150\text{ }^\circ\text{C}$ (see Figure 20) | | 290 | | ns | |
| Q_{rr} | Reverse recovery charge | | | - | 190 | | μC |
| I_{RRM} | Reverse recovery current | | | | 17 | | A |

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 μs , duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for D²PAK, I²PAK and TO-220

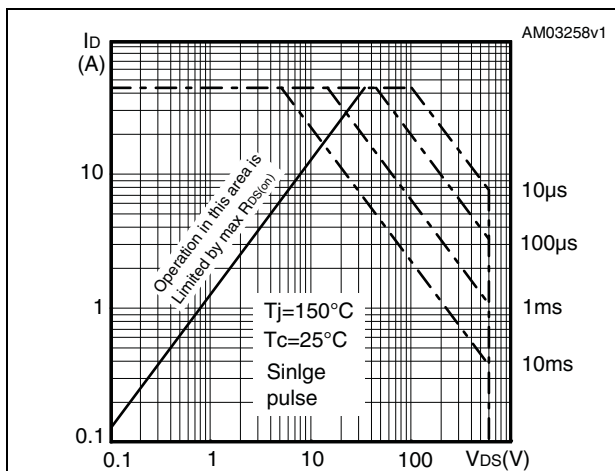


Figure 3. Thermal impedance for D²PAK, I²PAK and TO-220

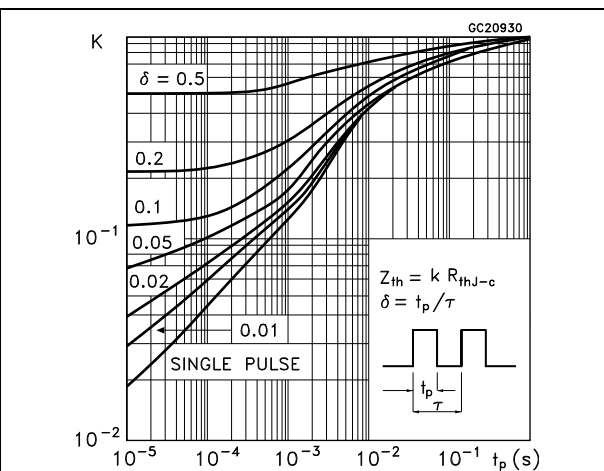


Figure 4. Safe operating area for TO-220FP

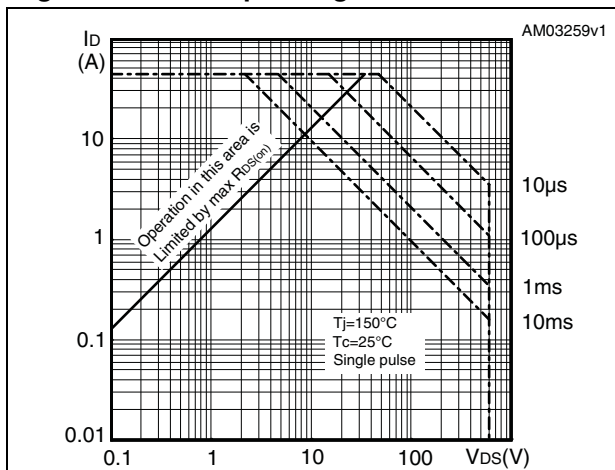


Figure 5. Thermal impedance for TO-220FP

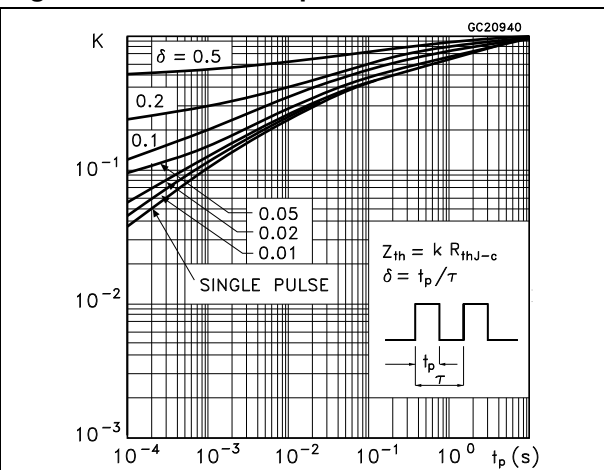


Figure 6. Safe operating area for TO-247

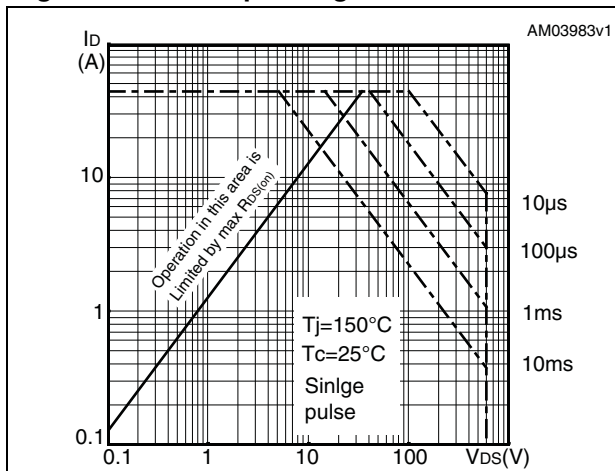


Figure 7. Thermal impedance for TO-247

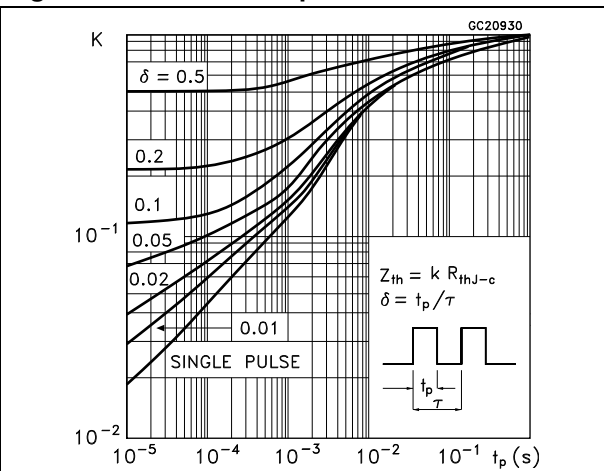


Figure 8. Safe operating area for DPAK and IPAQ

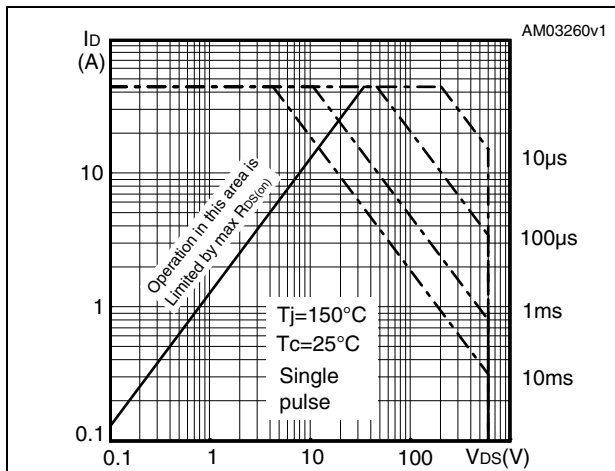


Figure 9. Thermal impedance for DPAK and IPAQ

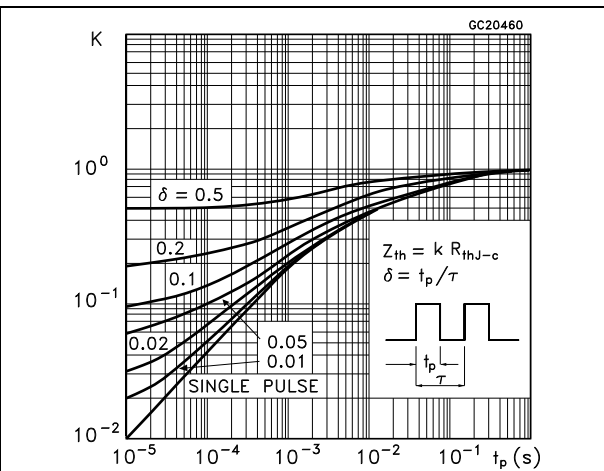


Figure 10. Output characteristics

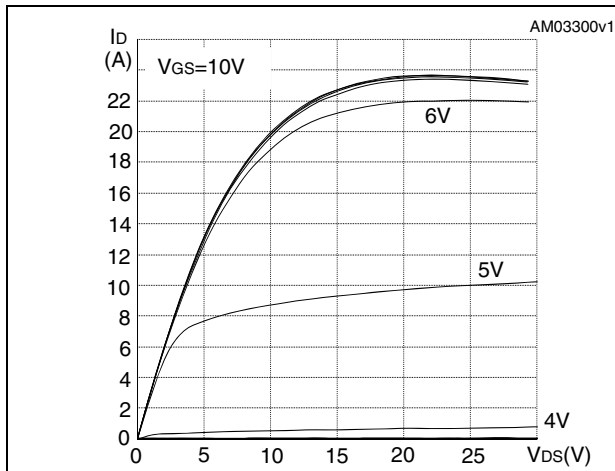


Figure 11. Transfer characteristics

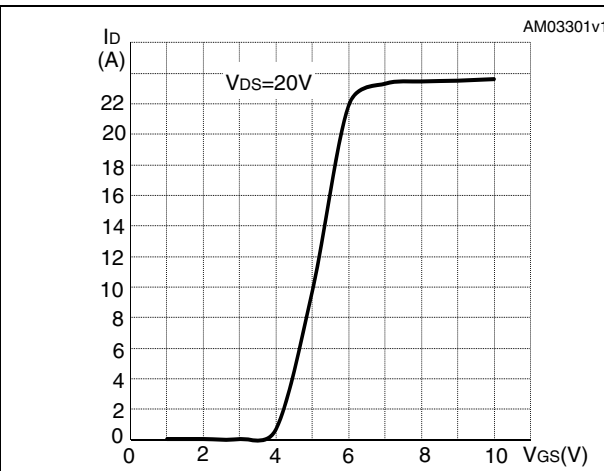


Figure 12. Normalized BV_{DSS} vs temperature

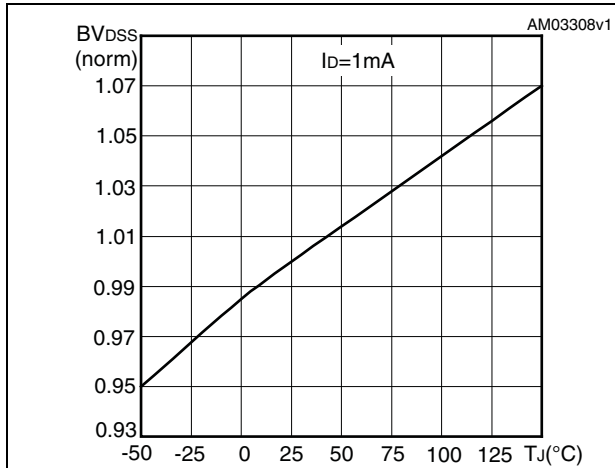


Figure 13. Static drain-source on resistance

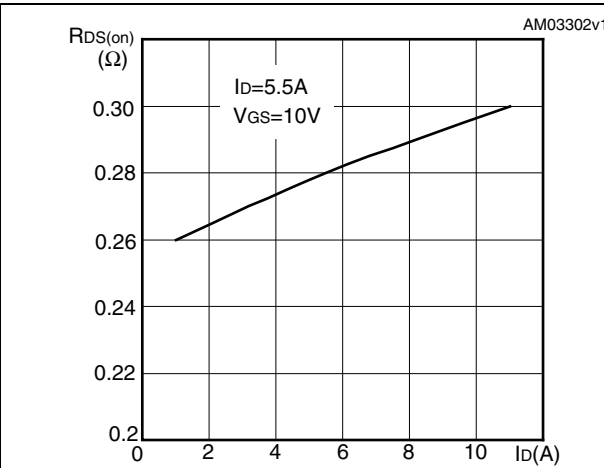


Figure 14. Gate charge vs gate-source voltage Figure 15. Capacitance variations

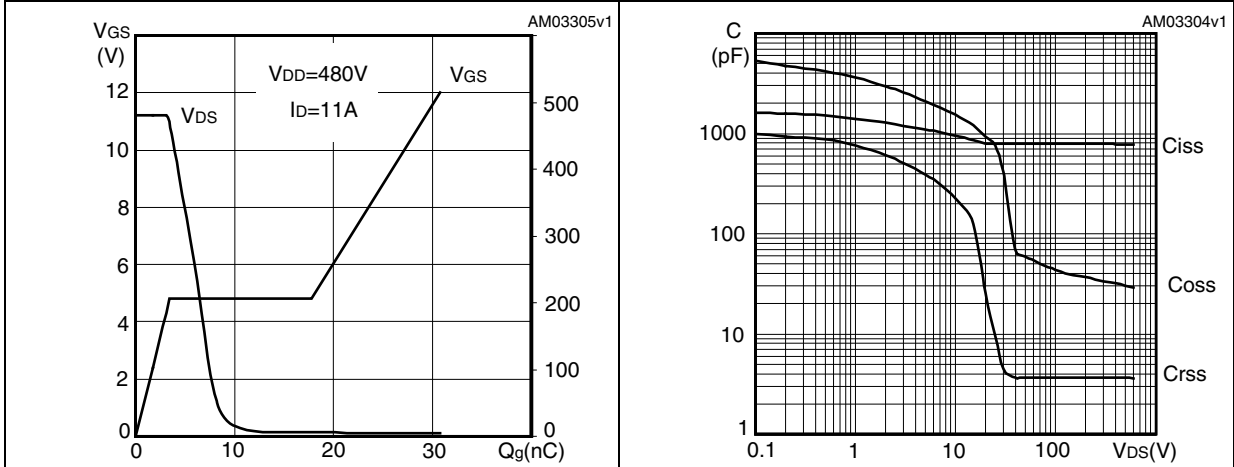
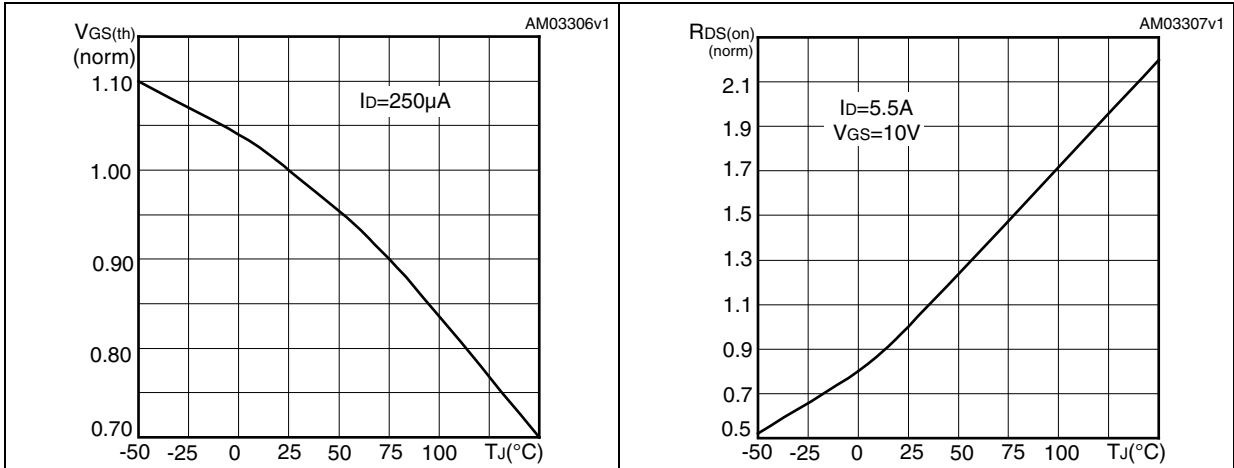


Figure 16. Normalized gate threshold voltage vs temperature Figure 17. Normalized on resistance vs temperature



3 Test circuits

Figure 18. Switching times test circuit for resistive load

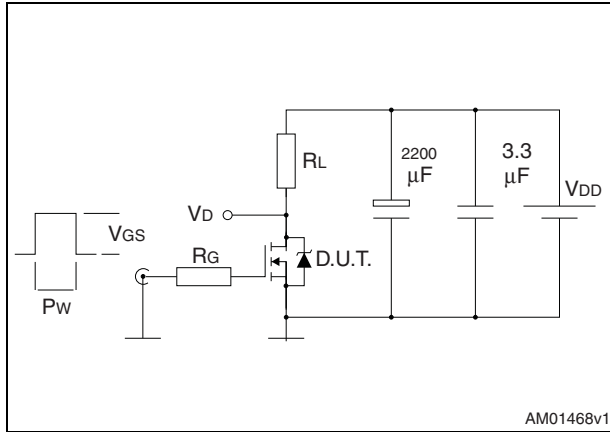


Figure 19. Gate charge test circuit

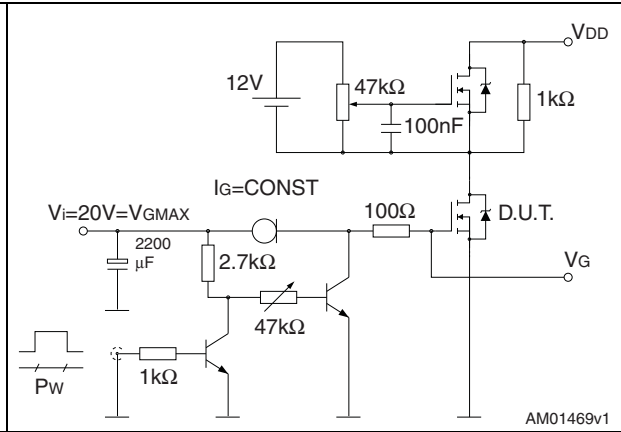


Figure 20. Test circuit for inductive load switching and diode recovery times

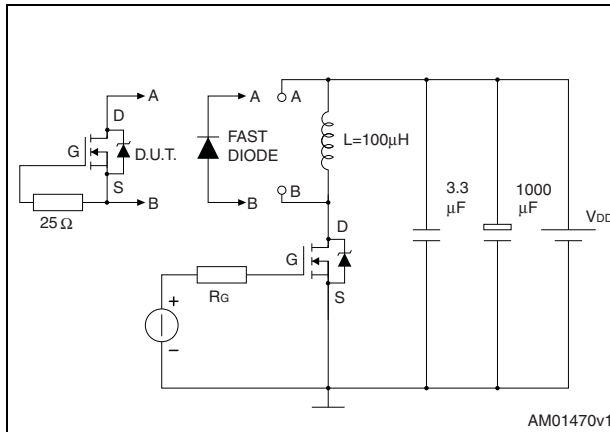


Figure 21. Unclamped inductive load test circuit

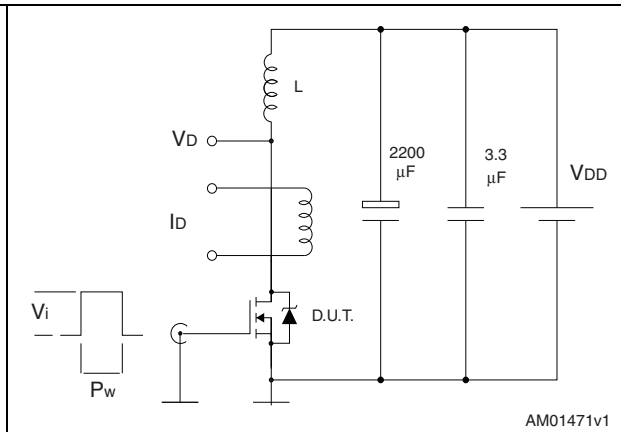


Figure 22. Unclamped inductive waveform

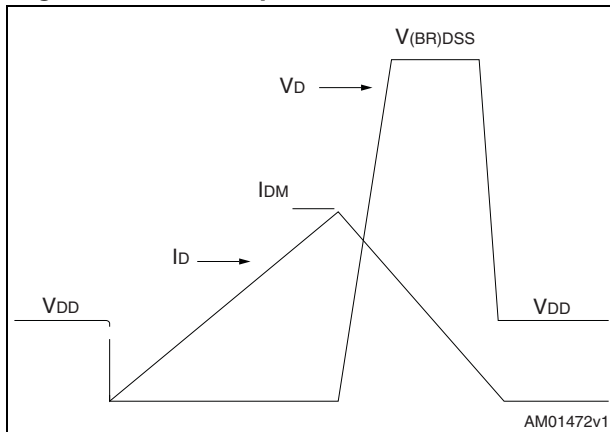
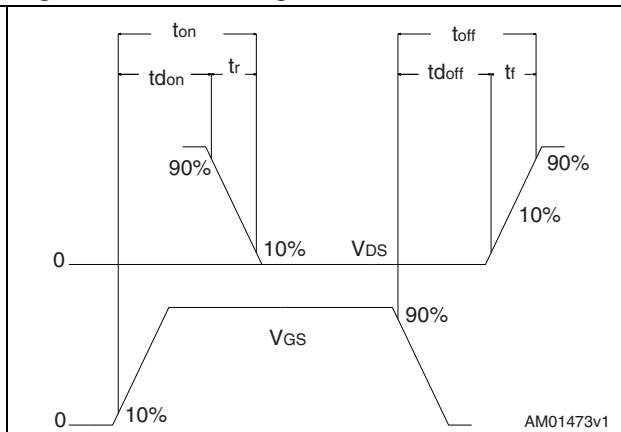


Figure 23. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. D²PAK (TO-263) mechanical data

| Dim. | mm | | |
|------|------|------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| A1 | 0.03 | | 0.23 |
| b | 0.70 | | 0.93 |
| b2 | 1.14 | | 1.70 |
| c | 0.45 | | 0.60 |
| c2 | 1.23 | | 1.36 |
| D | 8.95 | | 9.35 |
| D1 | 7.50 | | |
| E | 10 | | 10.40 |
| E1 | 8.50 | | |
| e | | 2.54 | |
| e1 | 4.88 | | 5.28 |
| H | 15 | | 15.85 |
| J1 | 2.49 | | 2.69 |
| L | 2.29 | | 2.79 |
| L1 | 1.27 | | 1.40 |
| L2 | 1.30 | | 1.75 |
| R | | 0.4 | |
| V2 | 0° | | 8° |

Figure 24. D²PAK (TO-263) drawing

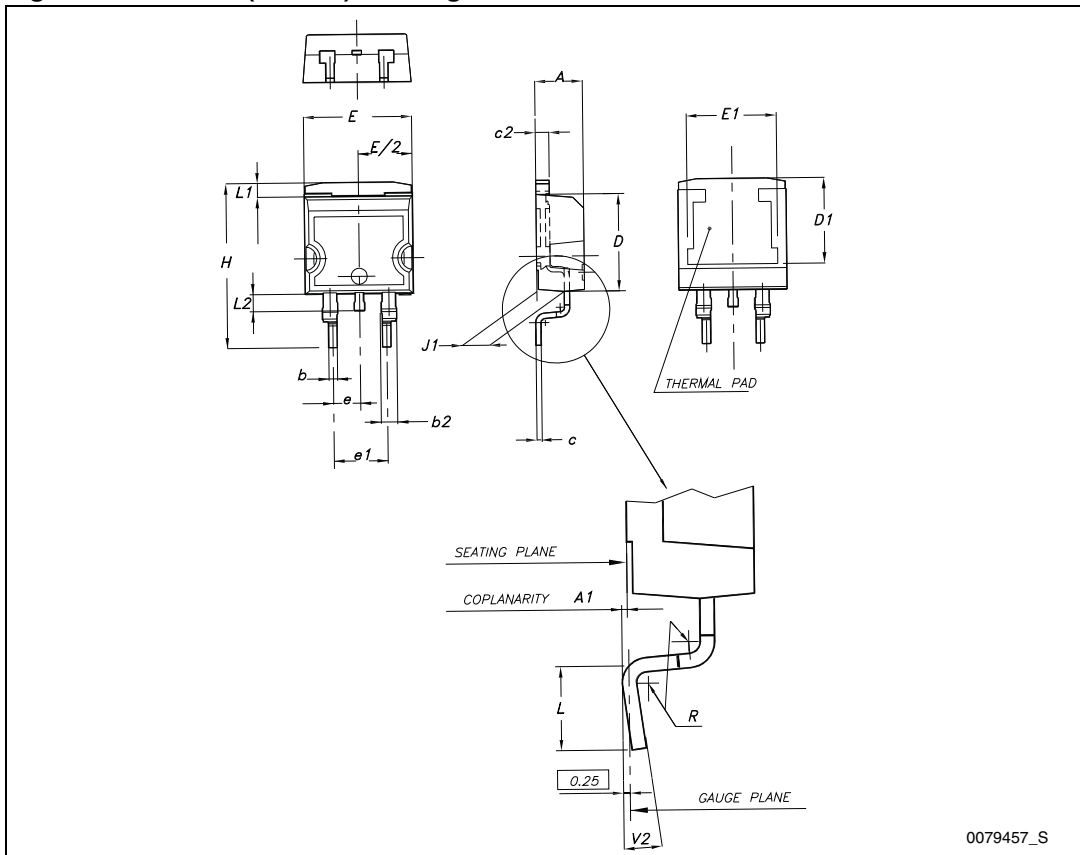


Table 10. DPAK (TO-252) mechanical data

| Dim. | mm | | |
|------|------|------|-------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| A2 | 0.03 | | 0.23 |
| b | 0.64 | | 0.90 |
| b4 | 5.20 | | 5.40 |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| D1 | | 5.10 | |
| E | 6.40 | | 6.60 |
| E1 | | 4.70 | |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | 9.35 | | 10.10 |
| L | 1 | | 1.50 |
| L1 | | 2.80 | |
| L2 | | 0.80 | |
| L4 | 0.60 | | 1 |
| R | | 0.20 | |
| V2 | 0° | | 8° |

Figure 25. DPAK (TO-252) drawing

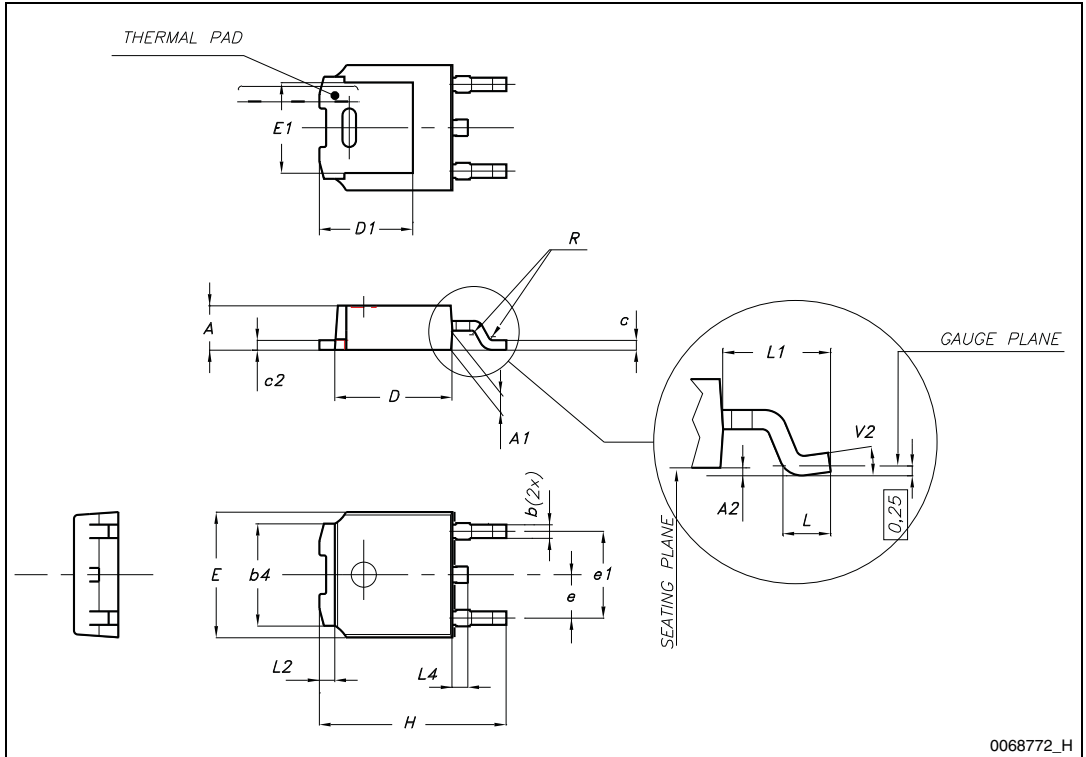
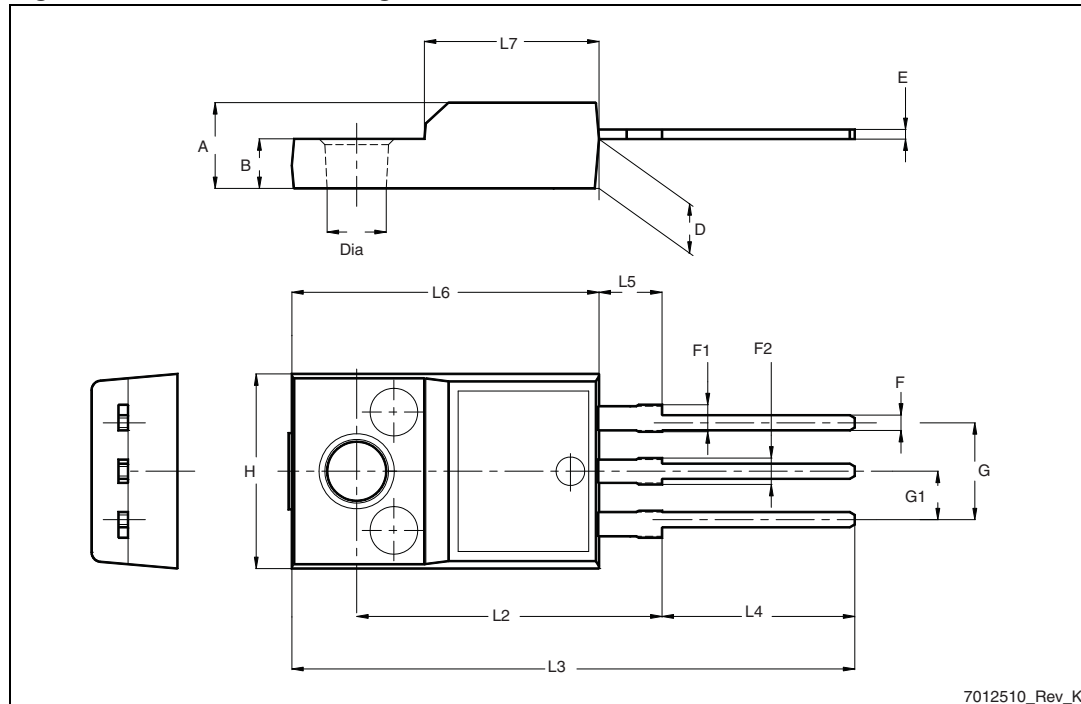


Table 11. TO-220FP mechanical data

| Dim. | mm | | |
|------|------|------|------|
| | Min. | Typ. | Max. |
| A | 4.4 | | 4.6 |
| B | 2.5 | | 2.7 |
| D | 2.5 | | 2.75 |
| E | 0.45 | | 0.7 |
| F | 0.75 | | 1 |
| F1 | 1.15 | | 1.70 |
| F2 | 1.15 | | 1.70 |
| G | 4.95 | | 5.2 |
| G1 | 2.4 | | 2.7 |
| H | 10 | | 10.4 |
| L2 | | 16 | |
| L3 | 28.6 | | 30.6 |
| L4 | 9.8 | | 10.6 |
| L5 | 2.9 | | 3.6 |
| L6 | 15.9 | | 16.4 |
| L7 | 9 | | 9.3 |
| Dia | 3 | | 3.2 |

Figure 26. TO-220FP drawing

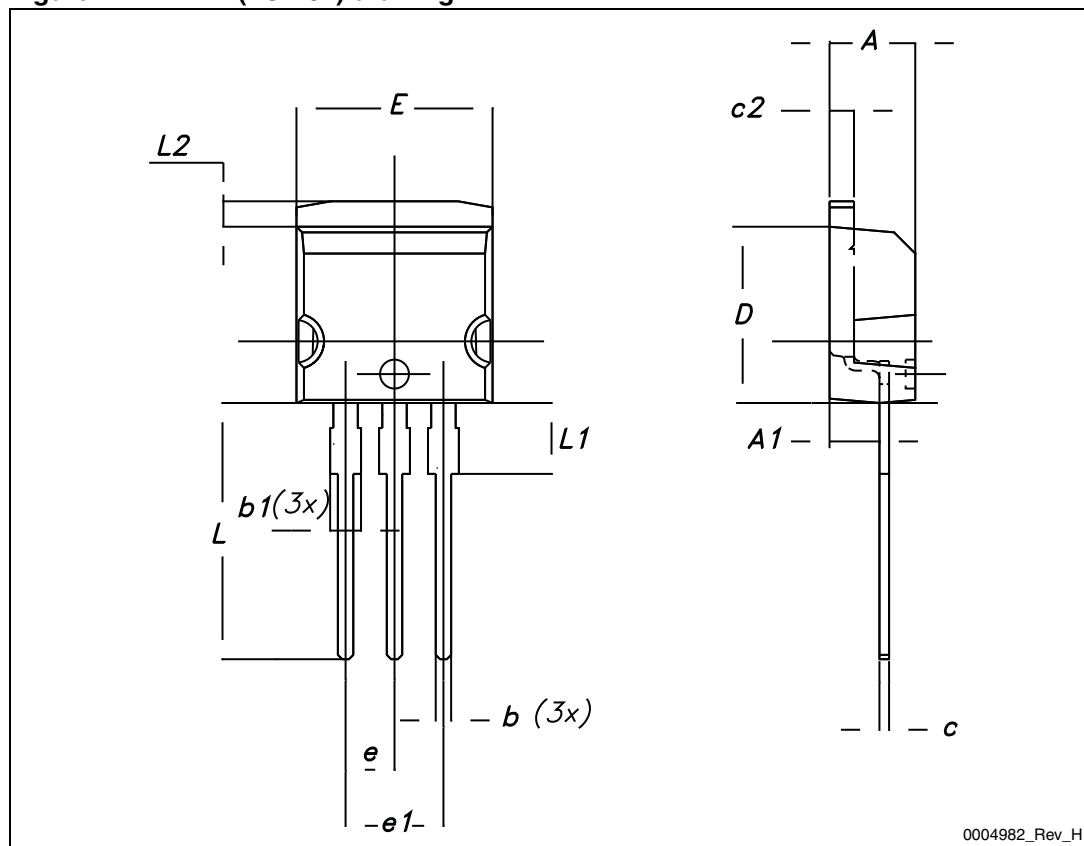


7012510_Rev_K

Table 12. I²PAK (TO-262) mechanical data

| DIM. | mm. | | |
|------|------|-----|-------|
| | min. | typ | max. |
| A | 4.40 | | 4.60 |
| A1 | 2.40 | | 2.72 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.49 | | 0.70 |
| c2 | 1.23 | | 1.32 |
| D | 8.95 | | 9.35 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| E | 10 | | 10.40 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L2 | 1.27 | | 1.40 |

Figure 27. I²PAK (TO-262) drawing



0004982_Rev_H

Table 13. TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Figure 28. TO-220 type A drawing

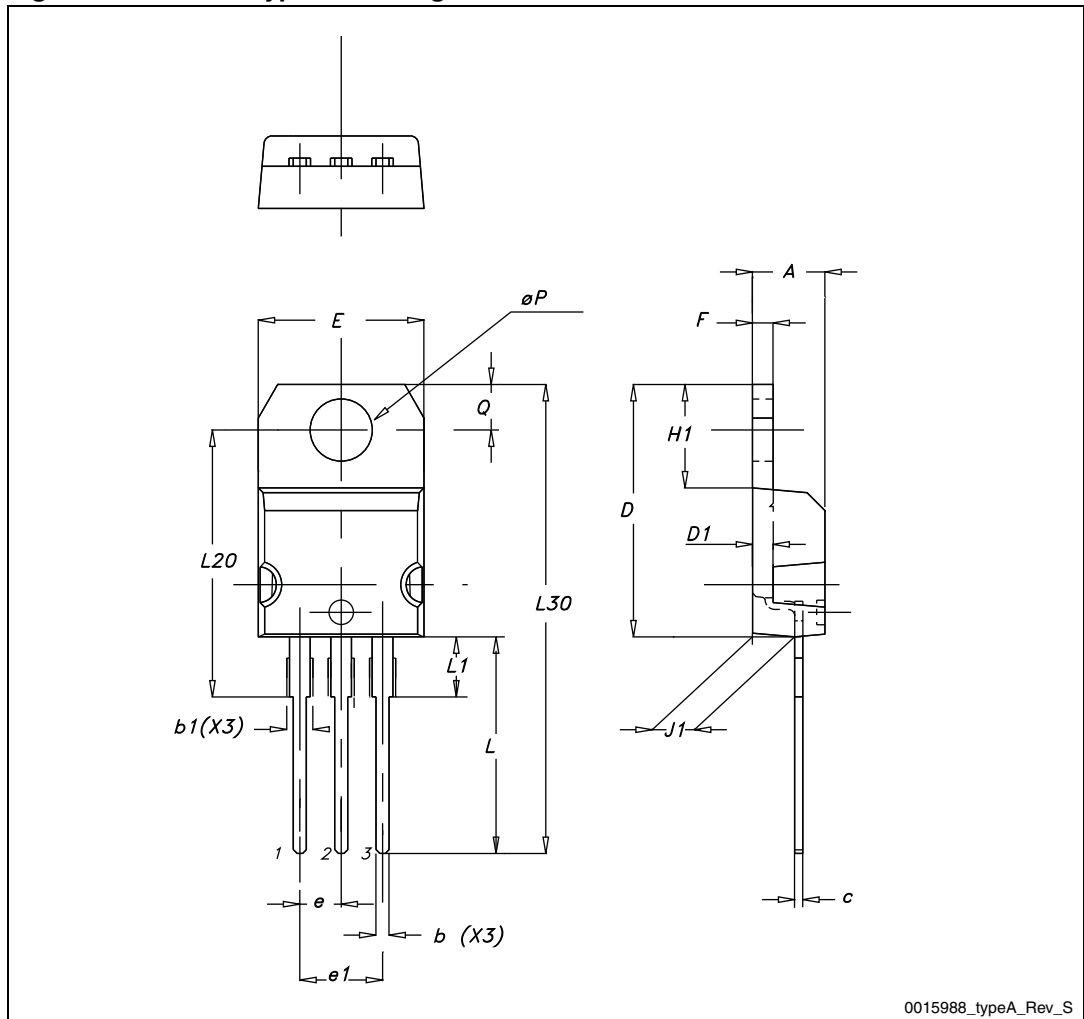


Table 14. IPAK (TO-251) mechanical data

| DIM. | mm. | | |
|------|------|-------|------|
| | min. | typ | max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| B5 | | 0.3 | |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | | 16.10 | |
| L | 9.00 | | 9.40 |
| L1 | 0.80 | | 1.20 |
| L2 | | 0.80 | 1.00 |
| V1 | | 10 ° | |

Figure 29. IPAK (TO-251) drawing

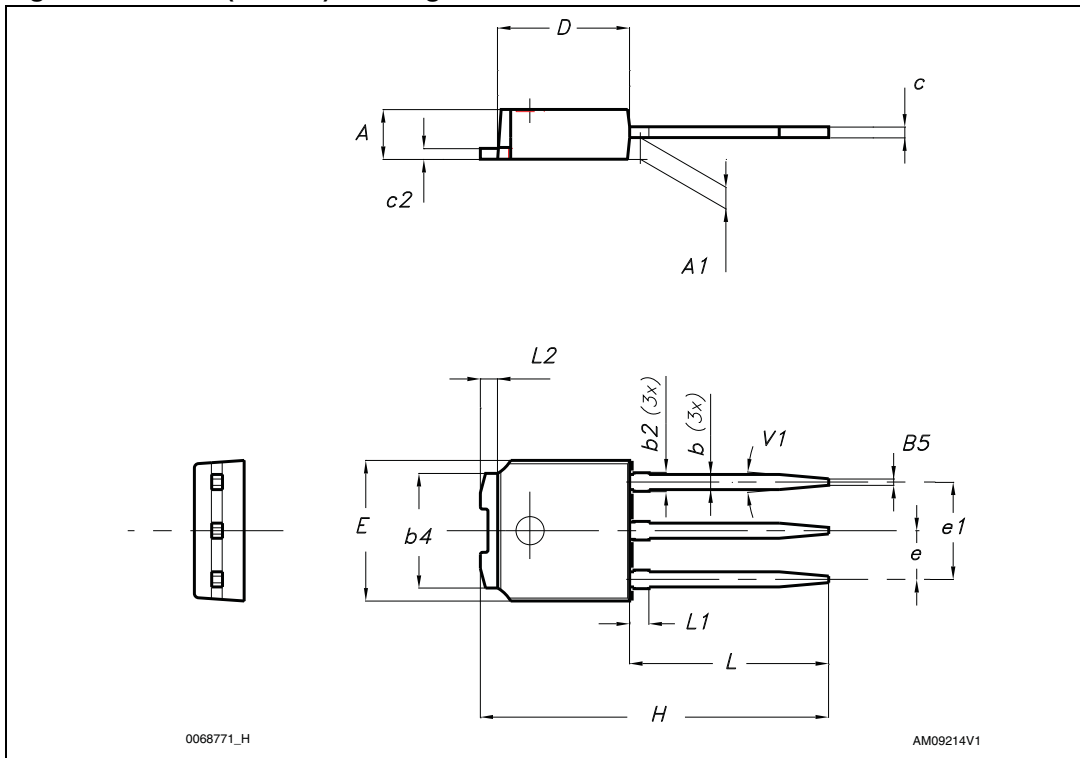
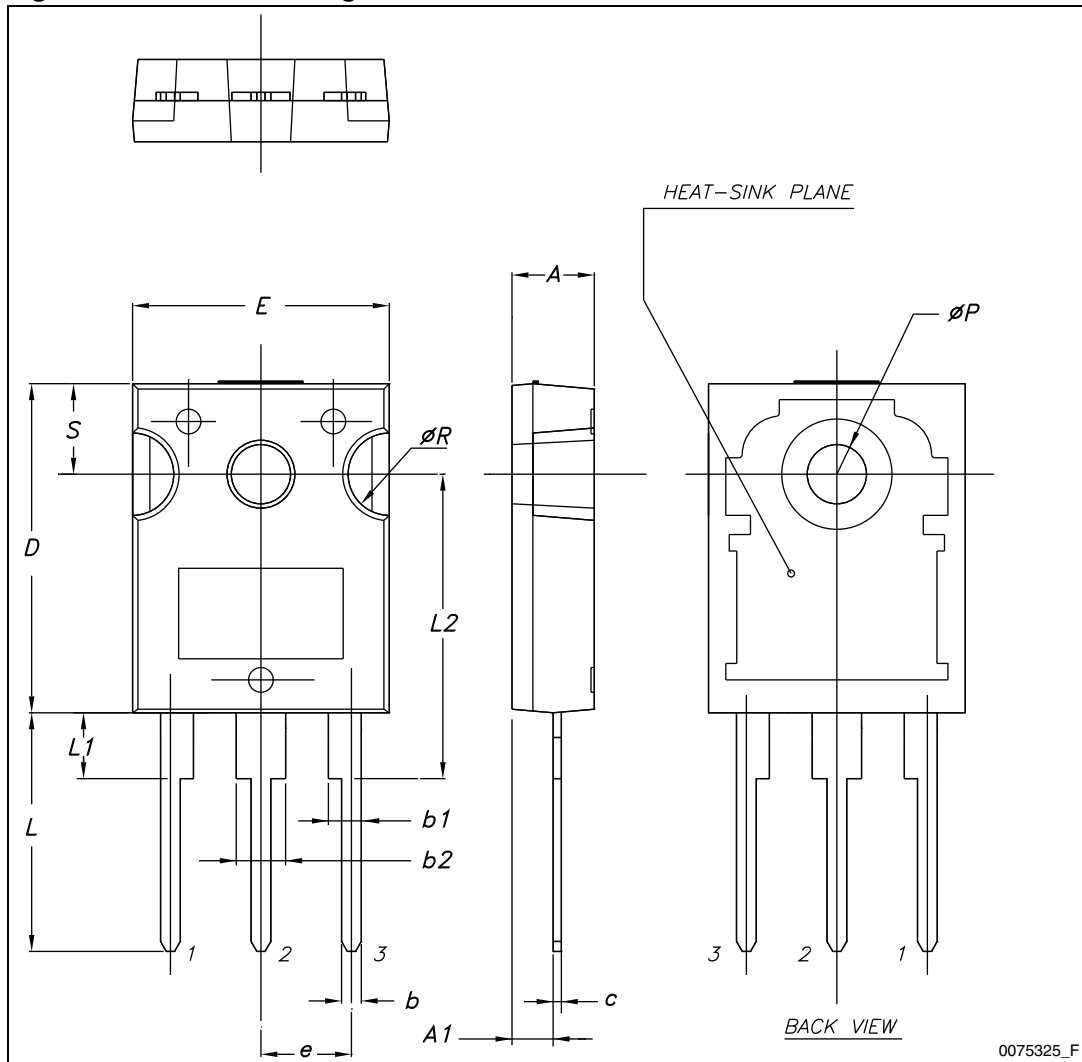


Table 15. TO-247 mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.85 | | 5.15 |
| A1 | 2.20 | | 2.60 |
| b | 1.0 | | 1.40 |
| b1 | 2.0 | | 2.40 |
| b2 | 3.0 | | 3.40 |
| c | 0.40 | | 0.80 |
| D | 19.85 | | 20.15 |
| E | 15.45 | | 15.75 |
| e | | 5.45 | |
| L | 14.20 | | 14.80 |
| L1 | 3.70 | | 4.30 |
| L2 | | 18.50 | |
| ØP | 3.55 | | 3.65 |
| ØR | 4.50 | | 5.50 |
| S | | 5.50 | |

Figure 30. TO-247 drawing



0075325_F

5 Packaging mechanical data

Table 16. D²PAK (TO-263) tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 10.5 | 10.7 | A | | 330 |
| B0 | 15.7 | 15.9 | B | 1.5 | |
| D | 1.5 | 1.6 | C | 12.8 | 13.2 |
| D1 | 1.59 | 1.61 | D | 20.2 | |
| E | 1.65 | 1.85 | G | 24.4 | 26.4 |
| F | 11.4 | 11.6 | N | 100 | |
| K0 | 4.8 | 5.0 | T | | 30.4 |
| P0 | 3.9 | 4.1 | | | |
| P1 | 11.9 | 12.1 | Base qty | | 1000 |
| P2 | 1.9 | 2.1 | Bulk qty | | 1000 |
| R | 50 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 23.7 | 24.3 | | | |

Figure 31. D²PAK footprint^(a)

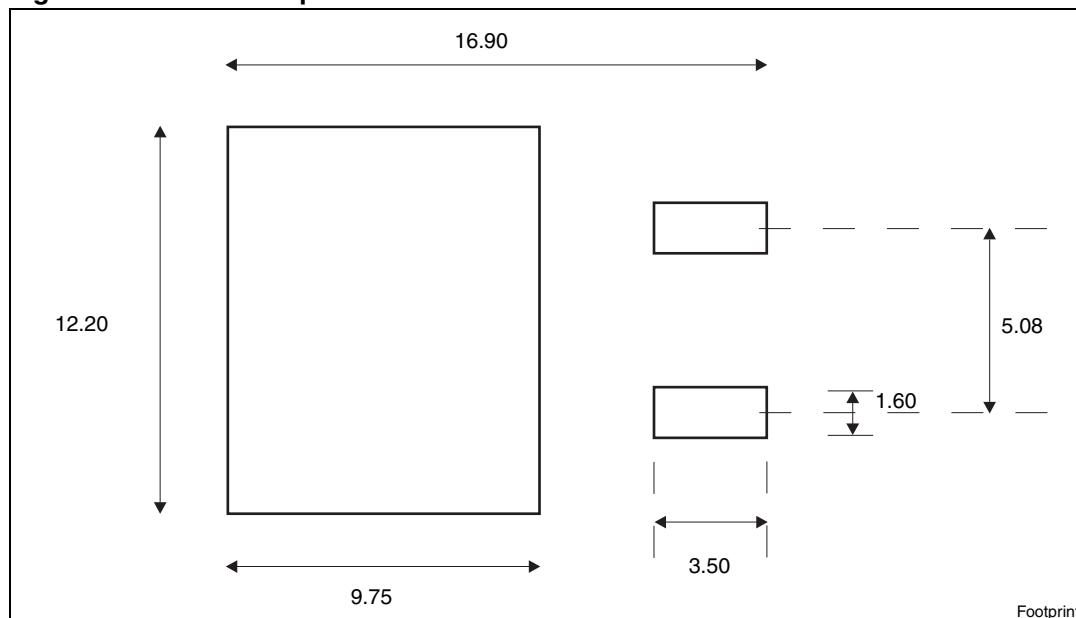
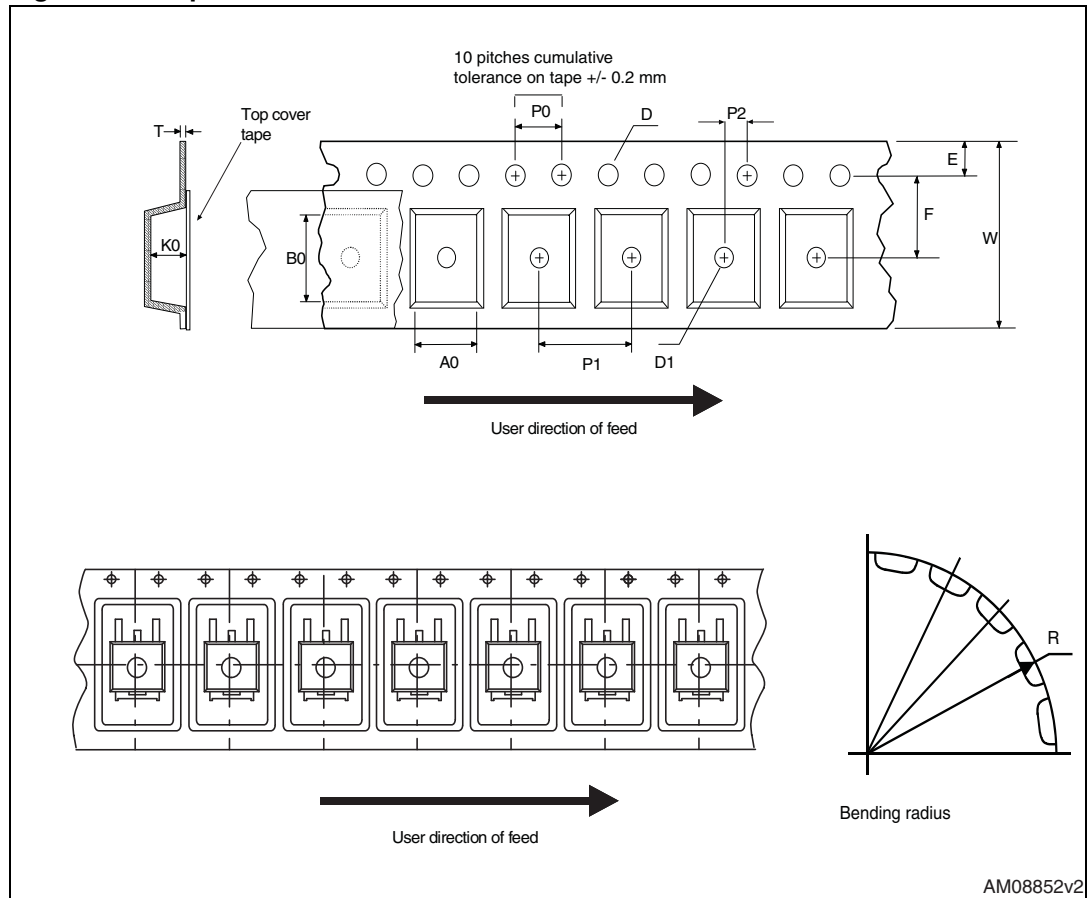


Figure 32. Tape



a. All dimensions are in millimeters

Figure 33. Reel

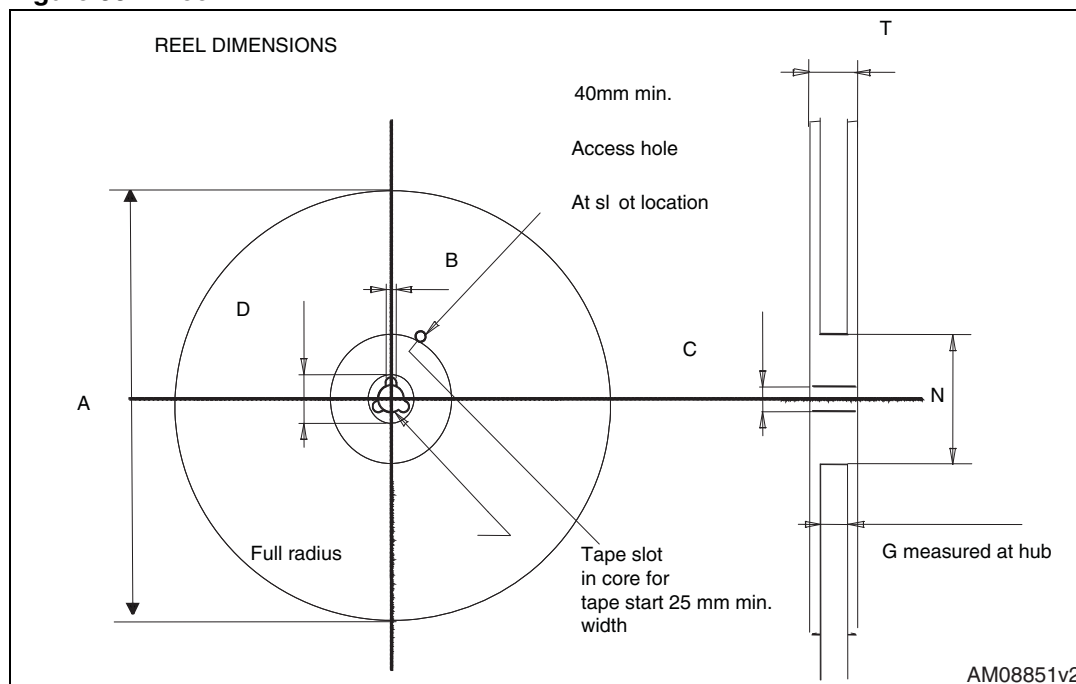
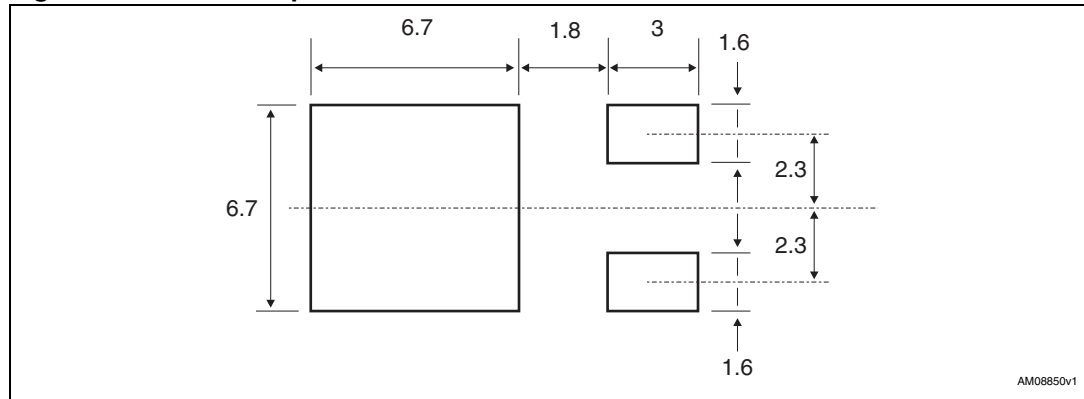


Table 17. DPAK (TO-252) tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|-----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 6.8 | 7 | A | | 330 |
| B0 | 10.4 | 10.6 | B | 1.5 | |
| B1 | | 12.1 | C | 12.8 | 13.2 |
| D | 1.5 | 1.6 | D | 20.2 | |
| D1 | 1.5 | | G | 16.4 | 18.4 |
| E | 1.65 | 1.85 | N | 50 | |
| F | 7.4 | 7.6 | T | | 22.4 |
| K0 | 2.55 | 2.75 | | | |
| P0 | 3.9 | 4.1 | Base qty. | | 2500 |
| P1 | 7.9 | 8.1 | Bulk qty. | | 2500 |
| P2 | 1.9 | 2.1 | | | |
| R | 40 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 15.7 | 16.3 | | | |

Figure 34. DPAK footprint^(b)



b. All dimensions are in millimeters

Figure 35. Tape for DPAK (TO-252)

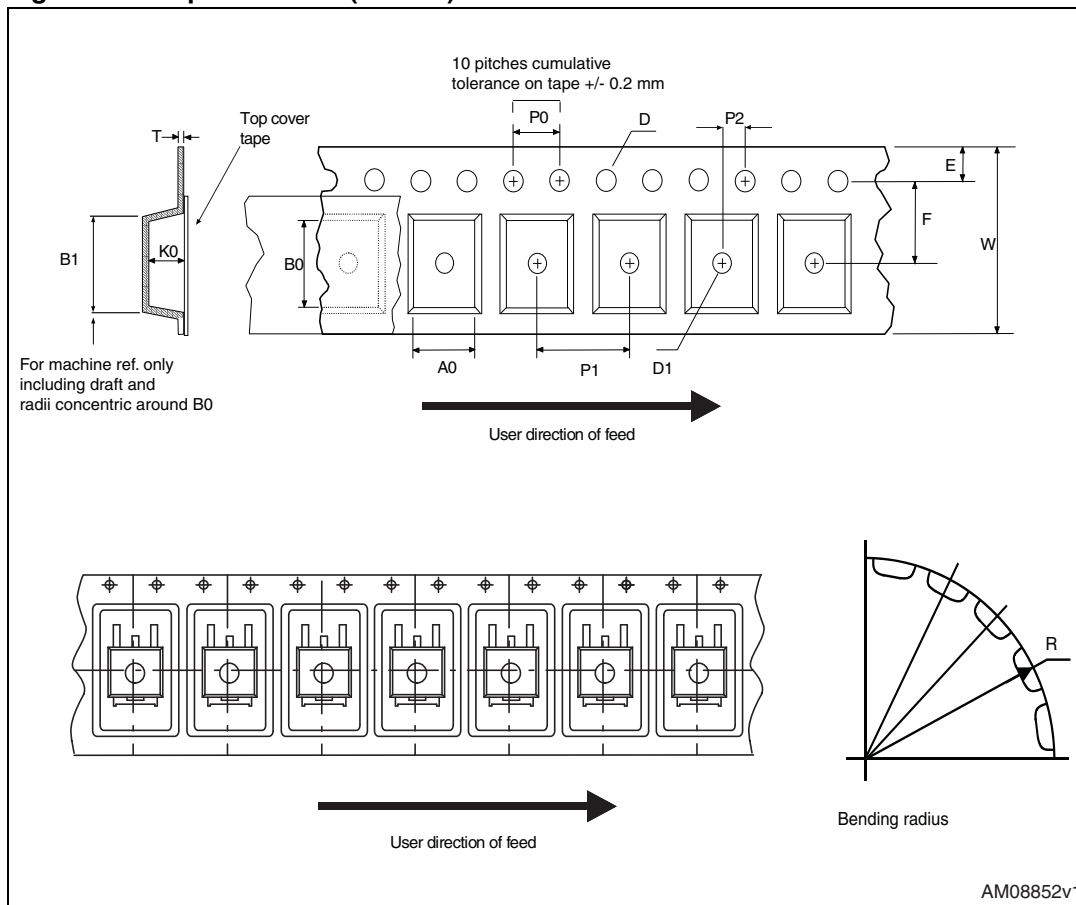
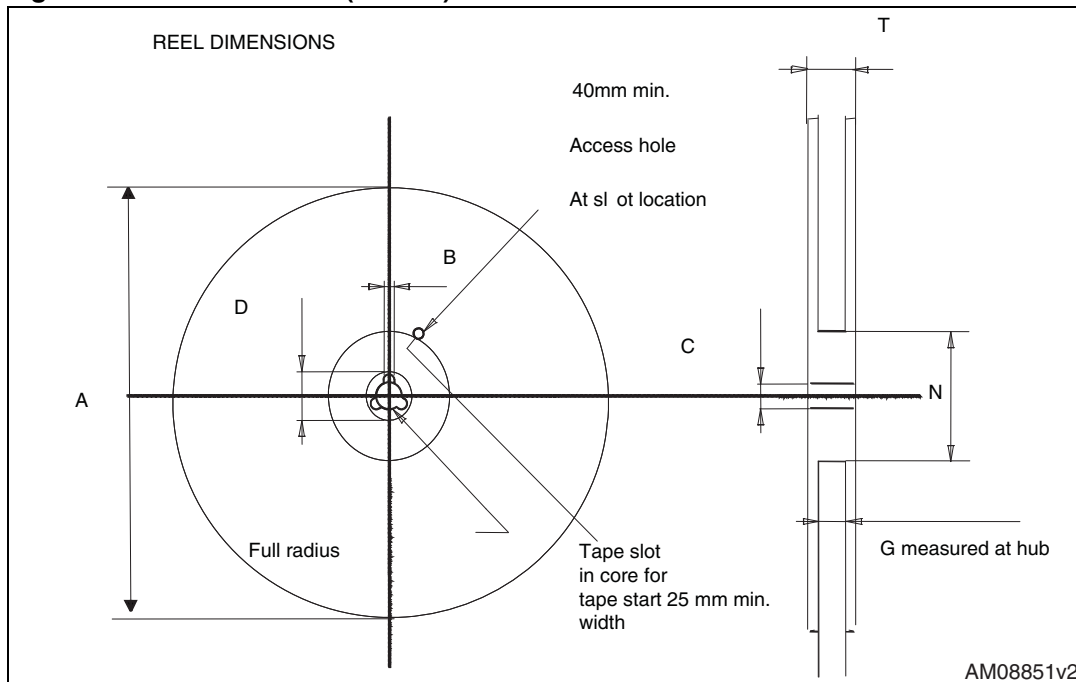


Figure 36. Reel for DPAK (TO-252)



6 Revision history

Table 18. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 29-Feb-2009 | 1 | First release |
| 13-Jan-2010 | 2 | – Added new package, mechanical data: TO-247 – Added new package, mechanical data: D ² PAK |
| 08-Nov-2010 | 3 | – Modified Figure 4 – Added new package, mechanical data: I ² PAK |
| 18-Jan-2012 | 4 | – Added new package, mechanical data: IPAK – Minor text changes |

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